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Express Mail No. ET156670463US
Attorney Docket No.: AM-5256-2

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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

IN RE APPLICATION OF: Jeng H. HWANG et al.

SERIAL NO.: 09/747,667

FILED: December 22, 2000

FOR: PLASMA HEATING OF A SUBSTRATE WITH
SUBSEQUENT HIGH TEMPERATURE ETCHING

§ GROUP ART UNIT: Unknown

§ EXAMINER: Unknown

§ Attorney Docket No.:
§ AM-5256-2

Date: May 3, 2001

INFORMATION DISCLOSURE STATEMENT
TRANSMITTAL LETTER

Hon. Commissioner for Patents
Washington, DC 20231

Sir:

Applicants are submitting the subject Information Disclosure Statement under 37 CFR § 1.97(b)(3). This Information Disclosure Statement is being submitted prior to the receipt of a first Office Action in the subject application.

CERTIFICATE OF MAILING UNDER 37 CFR 1.10

I hereby certify that this paper is being deposited with the U.S. Postal Service on the date shown below with sufficient postage as U.S. EXPRESS MAIL NO. ET156670463US in an envelope addressed to the: Commissioner for Patents, Box DD, Washington, DC 20231.

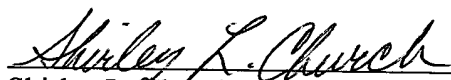
Date: May 3, 2001

Shirley L. Church
Shirley L. Church, Reg. No. 31,858

Applicants do not believe that any fee is due in connection with the filing of this Information Disclosure Statement under 37 CFR § 1.97(b)(3). However, in the event that any additional fee is due, the Commissioner is hereby authorized to charge Deposit Account No. 50-1512 of Shirley L. Church, Sunnyvale, California, in the amount of such fee.

This transmittal letter is submitted in duplicate for accounting purposes.

Respectfully submitted,


Shirley L. Church
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